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Should be replaced with:

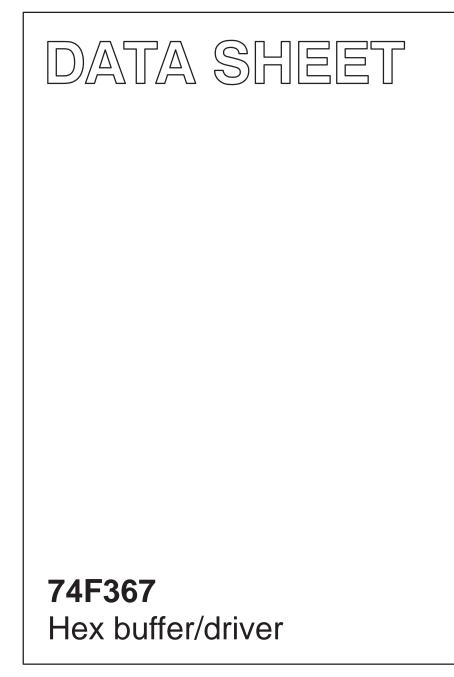
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Kind regards,

Team Nexperia

INTEGRATED CIRCUITS



Product data Replaces Product specification 74F365/74F367 of 2000 Jun 30 2004 Jan 30





74F367

FEATURES

- High-impedance NPN base inputs for reduced loading (20 µA in HIGH and LOW states)
- High-speed
- Bus oriented
- 3-State buffer outputs sink 64 mA

ORDERING INFORMATION

COMMERCIAL RANGE: V_{CC} = 5 V \pm 10%; T_{amb} = 0 °C to +70 °C

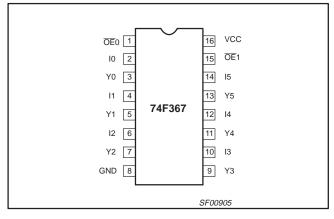
Type number	Package	ackage						
	Name	Description	Version					
N74F367N	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4					
N74F367D	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1					

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F(U.L.) HIGH / LOW	LOAD VALUE HIGH / LOW
10 - 15	Inputs	1.0 / 0.033	20 μΑ / 20 μΑ
<u>OE</u> 0, <u>OE</u> 1	Output enable inputs (active-LOW)	1.0 / 0.033	20 μΑ / 20 μΑ
Y0 - Y5	Data Outputs	750 / 106.7	15 mA / 64 mA

NOTE: One (1.0) FAST Unit Load (U.L.) is defined as: 20 µA in the HIGH state and 0.6 mA in the LOW state.

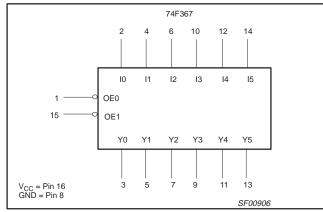
PIN CONFIGURATION



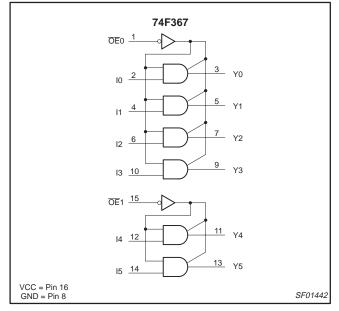
TYPE	Ξ	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F36	7	5.0 ns	36 mA

74F367

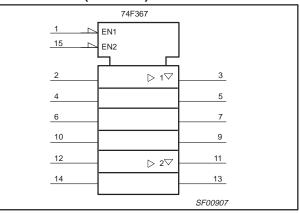
LOGIC SYMBOL



LOGIC DIAGRAM



LOGIC SYMBOL (IEEE/IEC)



FUNCTION TABLE

INP	OUTPUTS	
OEn	In	Yn
L	L	L
L	Н	н
н	Х	Z

H = HIGH voltage level L = LOW voltage level

X = Don't care Z = High impedance "off" state

74F367

ABSOLUTE MAXIMUM RATINGS

Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.

SYMBOL	PARAMETER	RATING	UNIT
V _{CC}	Supply voltage range	-0.5 to +7.0	V
V _{IN}	Input voltage range	-0.5 to +7.0	V
I _{IN}	Input current range	-30 to +5	mA
V _{OUT}	Voltage applied to output in HIGH output state range	-0.5 to 5.5	V
I _{OUT}	Current applied to output in LOW output state	128	mA
T _{amb}	Operating free-air temperature range	0 to +70	°C
T _{stg}	Storage temperature range	-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		UNIT		
STNIBUL	PARAMETER	MIN	ТҮР	MAX	
V _{CC}	Supply voltage	4.5	5.0	5.5	V
V _{IH}	HIGH-level input voltage	2.0	-	-	V
V _{IL}	LOW-level input voltage	-	-	0.8	V
I _{IK}	Input clamp current	-	-	-18	mA
I _{OH}	HIGH-level output current	-	-	-15	mA
I _{OL}	LOW-level output current	-	-	64	mA
T _{amb}	Operating free-air temperature range	0	-	70	°C

74F367

DC ELECTRICAL CHARACTERISTICS

Over recommended operating free-air temperature range unless otherwise noted.

OVMDO	DADAMETED	NC1	LIMITS			UNIT	
SYMBOL	PARAMETER	TEST CONDITIO	MIN	TYP ²	MAX	1	
		$V_{CC} = MIN; V_{IL} = MAX;$	± 10% Vcc	2.4	-	-	V
M		$V_{IH} = MIN; I_{OH} = -3 \text{ mA}$	± 5% Vcc	2.7	3.3	-	V
V _{OH}	HIGH-level output voltage	$V_{CC} = MIN; V_{IL} = MAX;$	± 10% Vcc	2.0	-	-	V
		$V_{IH} = MIN; I_{OH} = -15 \text{ mA}$	± 5% Vcc	2.0	-	-	V
V		V _{CC} = MIN; V _{IL} = MAX;	± 10% Vcc	-	-	0.55	V
V _{OL}	Low-level output voltage	$V_{IH} = MIN; I_{OL} = MAX$	± 5% Vcc	-	0.42	0.55	V
V _{IK}	Input clamp voltage	$V_{CC} = MIN; I_I =$	-	-0.73	-1.2	V	
l	Input current at maximum input voltage	$V_{CC} = 0 V; V_I = 7.0 V$		-	-	100	μA
I _{IH}	HIGH-level input current	$V_{CC} = MAX; V_I = 2.7 V$		-	-	20	μA
I _{IL}	LOW-level input current	$V_{CC} = MAX; V_I = 0.5 V$		-	-	-20	μA
I _{OZH}	Off-state output current, HIGH-level voltage applied	$V_{CC} = MAX; V_O = 1$	2.7 V	-	-	50	μΑ
I _{OZL}	Off-state output current, LOW-level voltage applied	$V_{CC} = MAX; V_O = 0.5 V$		-	-	-50	μΑ
I _{OS}	Short-circuit output current ³	V _{CC} = MAX		-100	-	-225	mA
	I _{ССН}			-	25	35	mA
I _{CC}	Supply current (total)	$V_{CC} = MAX$		-	47	62	mA
	I _{CCZ}]		-	35	48	mA

NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

 Por conditions shown as kind of MAX, use the appropriate value specified under recommended operating conditions for the appricable.
 All typical values are at V_{CC} = 5 V, T_{amb} = 25 °C.
 Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a HIGH output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

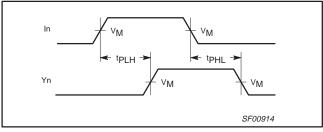
AC ELECTRICAL CHARACTERISTICS

					LIM	ITS		
SYMBOL	BOL PARAMETER TEST CONDITIONS		T _{amb} = +25 °C V _{CC} = +5.0 V C _L = 50 pF; R _L = 500 Ω			T _{amb} = −55 ° V _{CC} = +5. C _L = 50 pF;	UNIT	
			MIN	ТҮР	MAX	MIN	MAX	
t _{PLH} t _{PHL}	Propagation delay I_n to Y_n	Waveform 1	2.5 2.5	4.5 5.5	6.5 7.0	2.0 2.0	7.0 7.5	ns ns
t _{PZH} t _{PZL}	Output Enable time to HIGH or LOW level	Waveform 2 Waveform 3	3.0 3.0	5.5 6.5	7.5 8.5	3.0 3.0	8.5 9.0	ns ns
t _{PHZ} t _{PLZ}	Output Disable time from HIGH to LOW level	Waveform 2 Waveform 3	2.0 2.0	4.5 4.0	6.5 6.5	2.0 2.0	7.0 7.0	ns ns

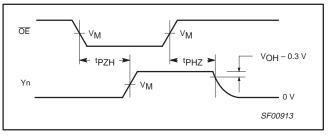
74F367

AC WAVEFORMS



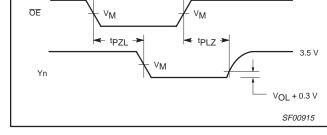


Waveform 1. For non-inverting outputs



Waveform 2. 3-State Output Enable time to HIGH level and Output Disable time from HIGH level

TEST CIRCUIT AND WAVEFORM



Waveform 3. 3-State Output Enable time to LOW level and Output Disable time from LOW level

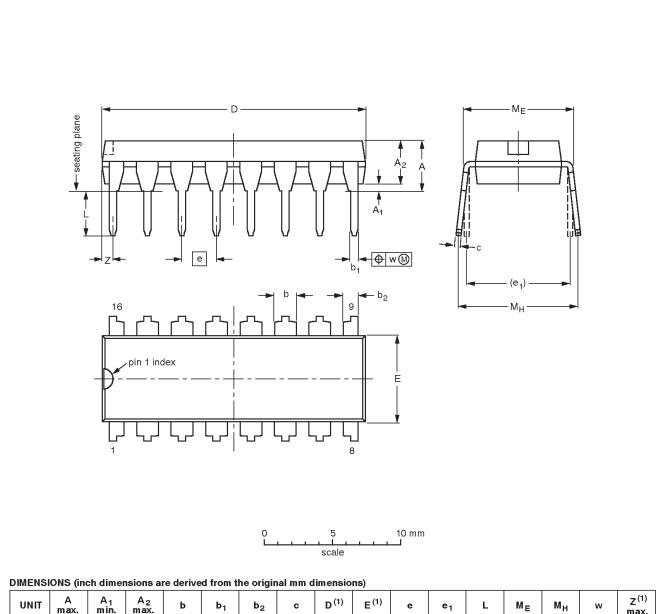
VCC • 7.0 V AMP (V) Ç 90% 90% NEGATIVE ₹ rl ٧M ٧M VIN PULSE VOUT 10% 10% PULSE D.U.T. 6 0 V GENERATOR tTHL (tf) tTLH (tr) ≩ _{RT} ξ R_L CL tTLH (tr) tTHL (tf) AMP (V) 90% 90% ÷ = ÷ -÷ -POSITIVE **Test Circuit for 3-State Outputs** PULSE ٧M VМ 10% 10% 0 V SWITCH POSITION TEST SWITCH **Input Pulse Definition** t_{PLZ} closed t_{PZL} closed All other open **DEFINITIONS:** R_L = Load resistor; **INPUT PULSE REQUIREMENTS** see AC electrical characteristics for value. family Load capacitance includes jig and probe capacitance; see AC electrical characteristics for value. C_{L} = V_{M} amplitude rep. rate tw t_{TLH} t_{THL} Termination resistance should be equal to Z_{OUT} of Rτ = 74F 3.0 V 1 MHz 500 ns 2.5 ns 2.5 ns 1.5 V pulse generators.

SF00777

2004 Jan 30

Product data

DIP16: plastic dual in-line package; 16 leads (300 mil)



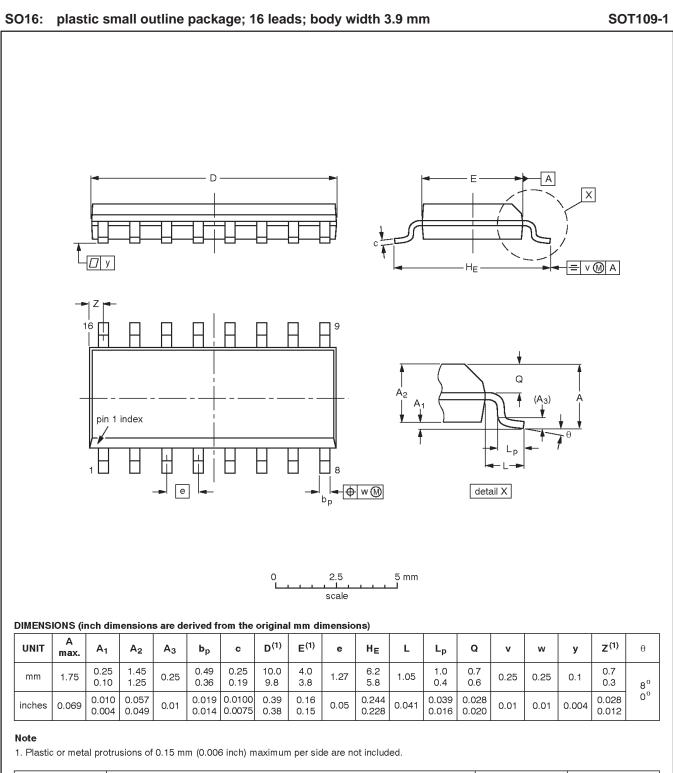
UNIT	max.	min.	max.	b	b ₁	b ₂	с	D(!)	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.02	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.1	0.3	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.03

Note

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

OUTLINE		REFEF	RENCES	EUROPEAN ISSUE DATE		
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE	
SOT38-4					-95-01-14 03-02-13	

74F367



74F367

REVISION HISTORY

Rev	Date	Description
_4	20040130	Product data (9397 750 12742). 853-0042 ECN 01-A15335 of 21 January 2004. Replaces 74F365_74F367_3 dated 2000 Jun 30 (9397 750 07283).
		Modifications:
		 Delete all references to 74F365 (product discontinued).
_3	20000630	Product specification (9397 750 07283). ECN 853-0042 24024 of 30 June 2000. Supersedes data of 1999 Jan 08.

Data sheet status

Level	Data sheet status ^[1]	Product status ^{[2] [3]}	Definitions
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

Definitions

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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For additional information please visit http://www.semiconductors.philips.com. Fax:

Fax: +31 40 27 24825

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